1/22/1/25 mm 3 mm 20 mm

ATTY. DOCKET NO. SERIAL NO. 4459-014A INFORMATION DISCLOSURE CITATION IN AN **APPLICANT** Kyujin JUNG ET AL APPLICATION FILING DATE **GROUP** December 19, 2001 (PTO-1449) U.S. PATENT DOCUMENTS FILING **EXAMINER'S CLASS SUBCLASS** DATE INITIALS NAME PATENT NO. DATE 3/2001 Yagi et al 6,201,292 6,198,171 3/2001 Huang et al K.N. 5,900,676 5/1999 Kweon et al K.N. 2/2001 Takata et al 6,187,614 K.N. 6,208,023 3/2001 Nakayama et al K.N FOREIGN PATENT DOCUMENTS Translation **EXAMINER'S** DATE COUNTRY **CLASS SUBCLASS** Yes **INITIALS** PATENT NO. OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.) R.O.C. Publication No. 348306, dated November 7, 1985, entitled DEVICE HAVING RESIN PACKAGE AND METHOD OF PRODUCING THE SAME (English Abstract) K.N. **EXAMINER** DATE CONSIDERED

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.